

HPX Silicone Thermal Conductive Paste 5000 g - Plastic Bucket

Product ID: 23453

Price: 286.00 EUR

Product weight: 5.00 kg

Description:

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HPX silicone paste is a thermal conductive preparation used as an intermediate layer between electronic components and heat sinks. The product is characterized by a thermal conductivity of over 2.80 W/mK and a density of 2.0 g/cm?. The material maintains its properties within an operating temperature range from -50°C to 250°C. The preparation does not conduct electricity and demonstrates chemical resistance to acids, bases, and ammonia.

Go to the product

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